

## Product Summary

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F</sub> MAX (V)	I <sub>R</sub> MAX (μA)
40	0.5	0.46	75

## Description

The SDM05U40CSP is a 40-volt 0.5A Schottky barrier rectifier that is optimized for low forward voltage drop and low leakage current, housed in a compact chip scale package (CSP) that occupies only 0.6mm<sup>2</sup> board-space. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space.

## Applications

It is ideally suited for use in portable applications as a:

- Blocking Diode
- Boost Diode
- Switching Diode
- Reverse Protection Diode

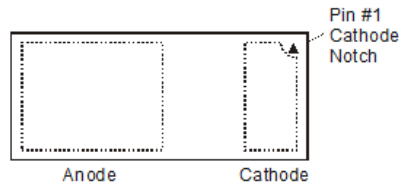


## Features and Benefits

- Off Board Profile of 0.275mm – More than 30% Thinner than DFN1006
- Low Forward Voltage (V<sub>F</sub>) Minimizes Conduction Losses and Improves Efficiency
- Reduced High Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: X3-WLB1006-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Dot
- Weight: 0.001 grams



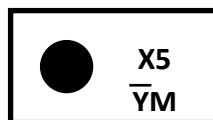
## Ordering Information (Note 4)

Part Number	Case	Packaging
SDM05U40CSP-7	X3-WLB1006-2	5,000/ Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information

Pin 1



X5= Product Type Marking Code  
 YM or ȲM =Date Code Marking  
 Y= Year (ex: D= 2016)  
 M=Month (ex: 9= September)  
 Dot Denotes Cathode Pin

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020
Code	B	C	D	E	F	G	H

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	40	V
Average Rectified Output Current	I <sub>O</sub>	0.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	14	A

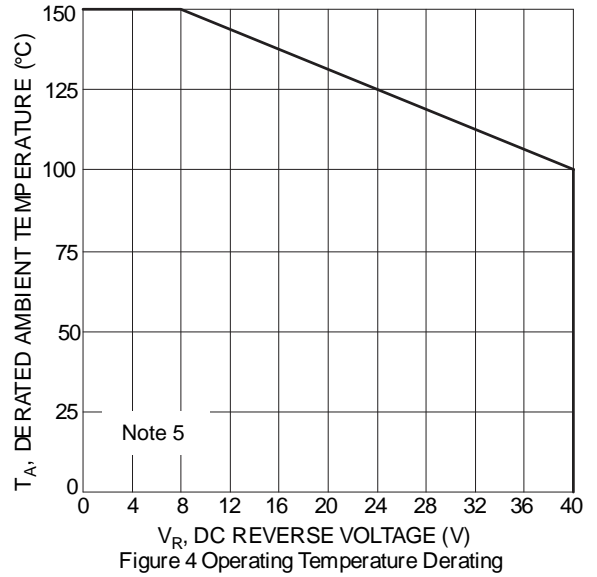
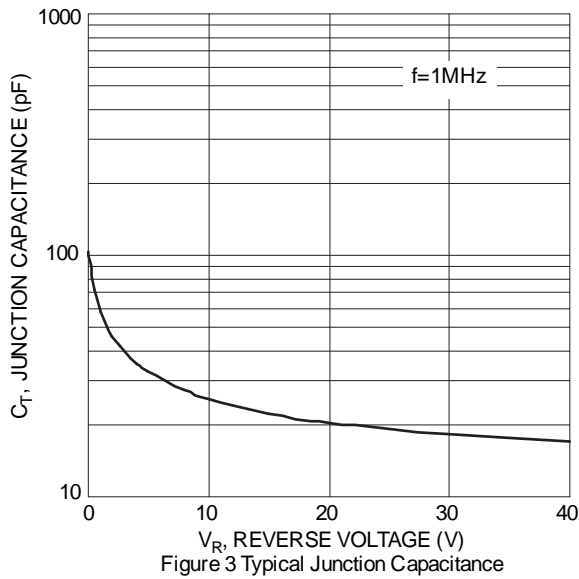
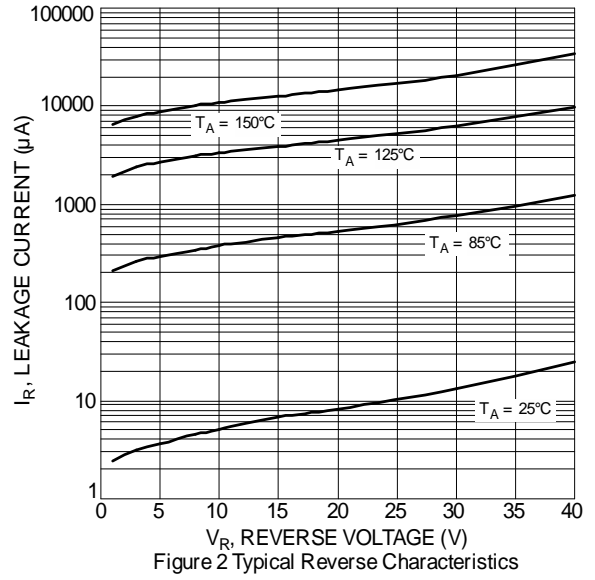
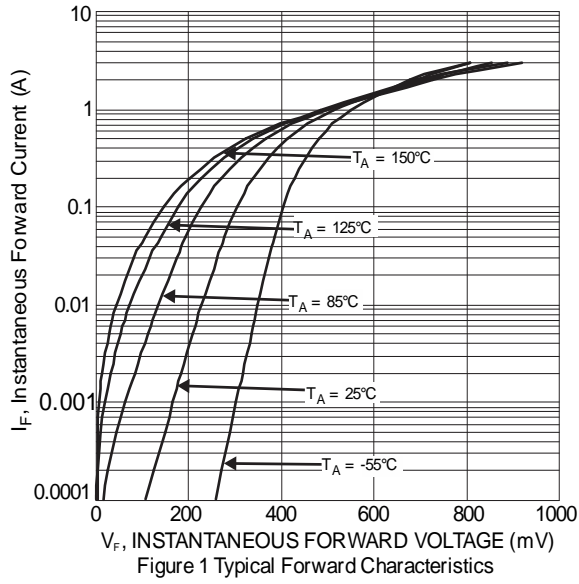
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	135	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R <sub>θJA</sub>	80	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

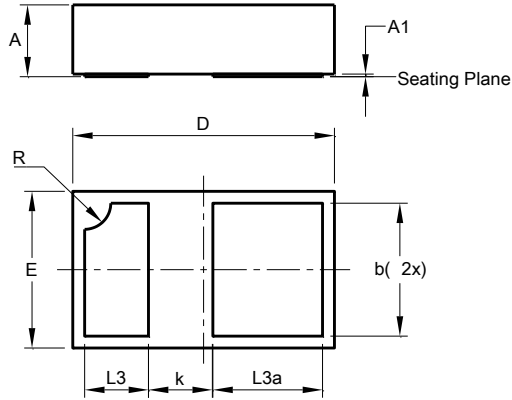
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	–	0.305	0.36	V	I <sub>F</sub> = 0.1A
		–	0.415	0.46		I <sub>F</sub> = 0.5A
		–	0.34	–		I <sub>F</sub> = 0.5A, T <sub>J</sub> = +125°C
Leakage Current (Note 7)	I <sub>R</sub>	–	–	15	μA	V <sub>R</sub> = 10V
		–	–	75		V <sub>R</sub> = 40V
Junction Capacitance	C <sub>T</sub>	–	35	–	pF	V <sub>R</sub> = 4V, f = 1.0MHz

- Notes:
5. Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  6. Device mounted on FR-4 PCB, 2oz. 1 square inch Copper.
  7. Short duration pulse test used to minimize self-heating effect.



## Package Outline Dimensions

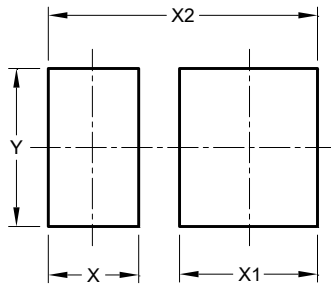
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



X3-WLB1006-2			
Dim	Min	Max	Typ
A	0.25	0.30	0.275
A1	0.00	0.01	-
b	0.450	0.550	0.500
D	0.95	1.05	1.000
E	0.55	0.65	0.600
k	-	-	0.288
L3	0.194	0.294	0.244
L3a	0.350	0.450	0.400
R	-	-	0.100
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
X	0.332
X1	0.507
X2	0.989
Y	0.579

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